



**THE DATASHEET OF
MURS230T3**



Power Rectifier, Ultra-Fast Recovery, 2 A, 300-400 V

MURS230, NRVUS230, NRVUS230V, MURS240, NRVUS240, NRVUS240V

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.95 Volts Max @ 2.0 A, T_J = 150°C)
- NRVUS and SURS8 Prefixes for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable*
- These Devices are Pb-Free and are RoHS Compliant

Mechanical Characteristics:

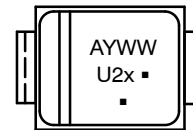
- Case: Epoxy, Molded
- Weight: 95 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Rating:
 - ◆ Human Body Model = 3 A (> 4 kV)
 - ◆ Charged Device Model > 1000 V

ULTRAFAST RECTIFIERS 2 AMPERES, 300-400 VOLTS



SMB
CASE 403A

MARKING DIAGRAM



- A = Assembly Location
- Y = Year
- WW = Work Week
- U2x = Device Code
 - x = F for MURS230T3
 - = G for MURS240T3
- = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping† |
|---|---------------|---------------------|
| MURS230T3G | SMB (Pb-Free) | 2,500 / Tape & Reel |
| NRVUS230T3G*, NRVUS230VT3G*, NRVUS230VT3G-GA01* | SMB (Pb-Free) | 2,500 / Tape & Reel |
| MURS240T3G | SMB (Pb-Free) | 2,500 / Tape & Reel |
| NRVUS240T3G*, NRVUS240VT3G*, NRVUS240VT3G-GA01* | SMB (Pb-Free) | 2,500 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MURS230, NRVUS230, NRVUS230V, MURS240, NRVUS240, NRVUS240V

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|---------------------------------|-------------|------------------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURS230T3G/NRVUS230T3G/NRVUS230VT3G-GA01 MURS240T3G/NRVUS240T3G/NRVUS240VT3G-GA01 | V_{RRM} V_{RWM} V_R | 300 400 | V |
| Average Rectified Forward Current @ $T_L = 150^\circ\text{C}$ @ $T_L = 125^\circ\text{C}$ | $I_{F(AV)}$ | 1.0 2.0 | A |
| Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz) | I_{FSM} | 35 | A |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -65 to +175 | $^\circ\text{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Rating | Symbol | Max | Unit |
|---|-----------------|-----|---------------------------|
| Thermal Resistance, Junction-to-Lead ($T_L = 25^\circ\text{C}$) | $R_{\theta JL}$ | 13 | $^\circ\text{C}/\text{W}$ |

ELECTRICAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|---|----------|--------------|---------------|
| Maximum Instantaneous Forward Voltage (Note 1) ($i_F = 2.0\text{ A}$, $T_J = 25^\circ\text{C}$) ($i_F = 2.0\text{ A}$, $T_J = 150^\circ\text{C}$) | V_F | 1.30 1.05 | V |
| Maximum Instantaneous Reverse Current (Note 1) (Rated DC Voltage, $T_J = 25^\circ\text{C}$) (Rated DC Voltage, $T_J = 150^\circ\text{C}$) | i_R | 5.0 150 | μA |
| Maximum Reverse Recovery Time ($i_F = 1.0\text{ A}$, $di/dt = 50\text{ A}/\mu\text{s}$) ($i_F = 0.5\text{ A}$, $i_R = 1.0\text{ A}$, I_R to 0.25 A) | t_{rr} | 65 50 | ns |
| Maximum Forward Recovery Time ($i_F = 1.0\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$, Rec. to 1.0 V) | t_{fr} | 50 | ns |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

MURS230, NRVUS230, NRVUS230V, MURS240, NRVUS240, NRVUS240V

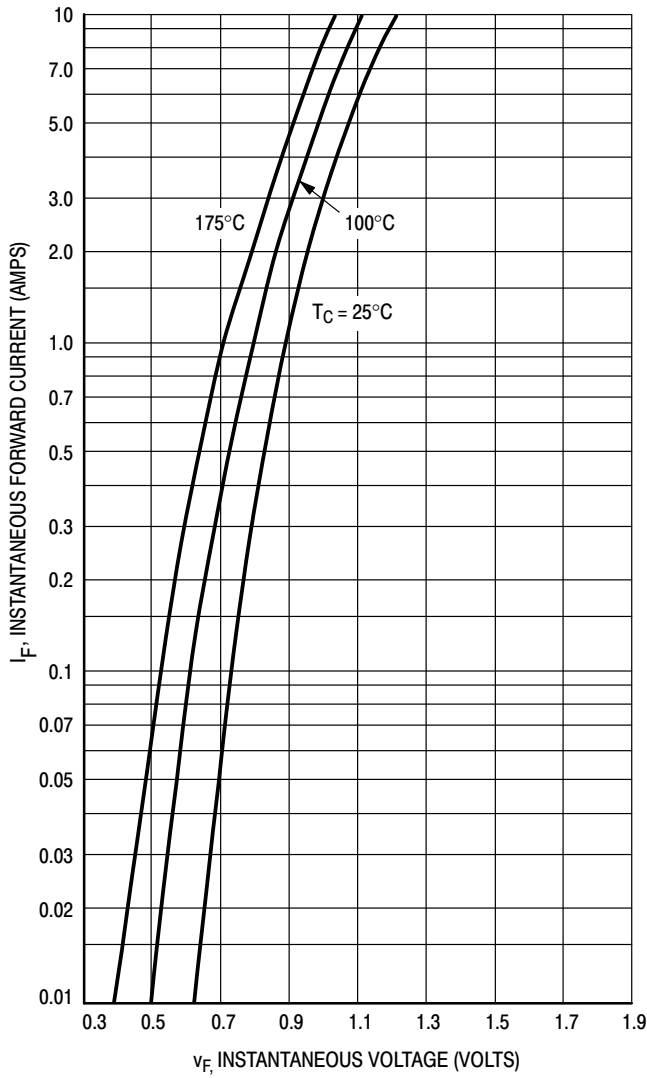


Figure 1. Typical Forward Voltage

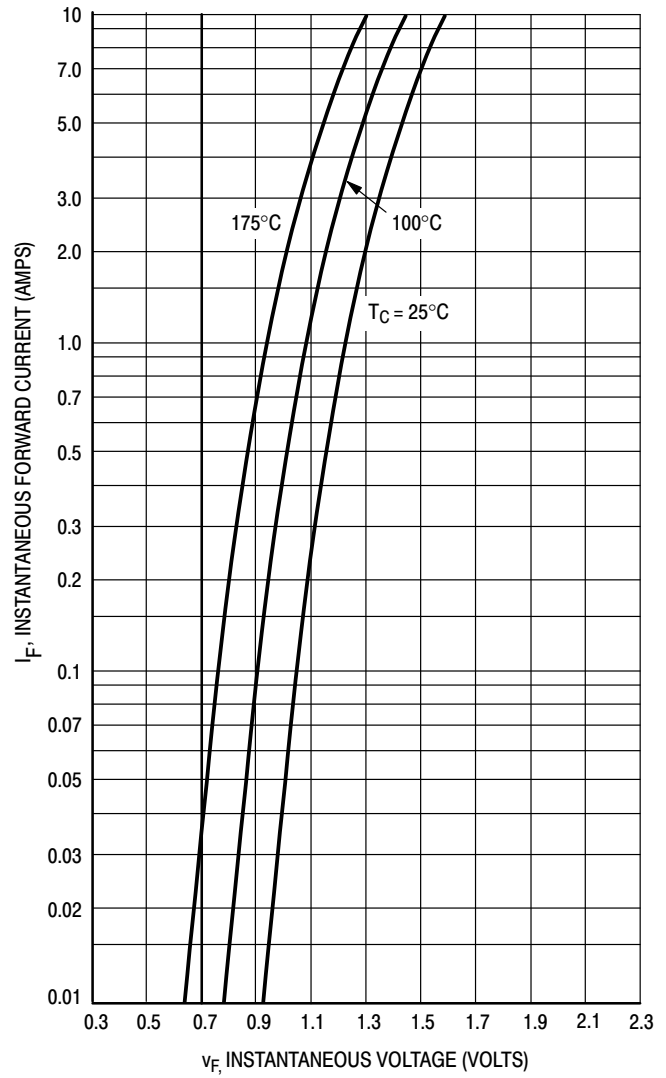


Figure 2. Maximum Forward Voltage

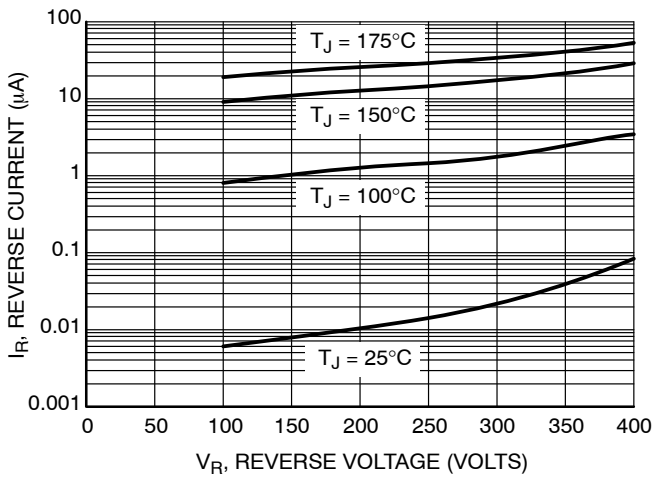


Figure 3. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if applied V_R is sufficiently below rated V_R .

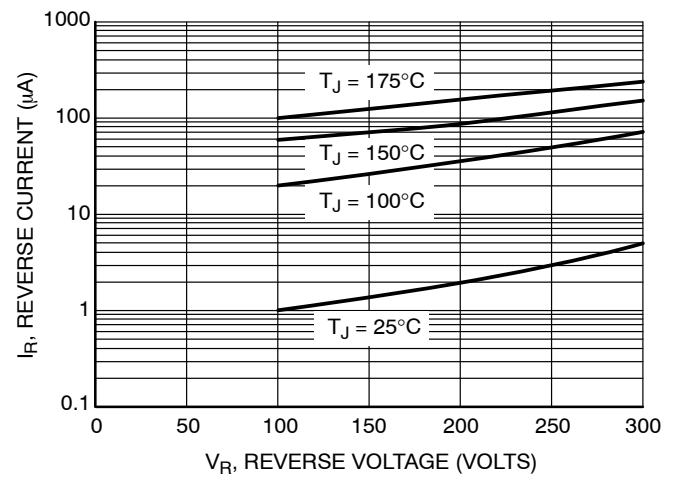


Figure 4. Maximum Reverse Current for MURS230T3G, NRVUS230T3G

MURS230, NRVUS230, NRVUS230V, MURS240, NRVUS240, NRVUS240V

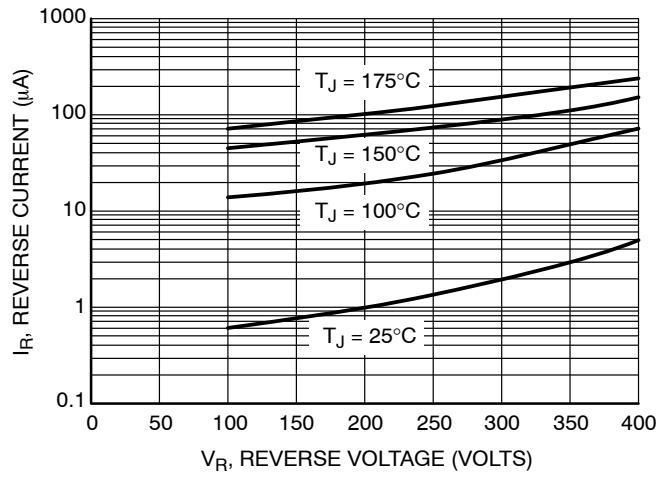


Figure 5. Maximum Reverse Current for MURS240T3G, NRVUS240T3G

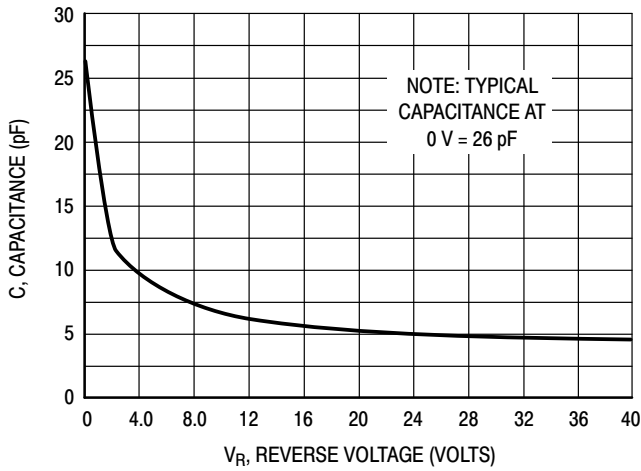


Figure 6. Typical Capacitance

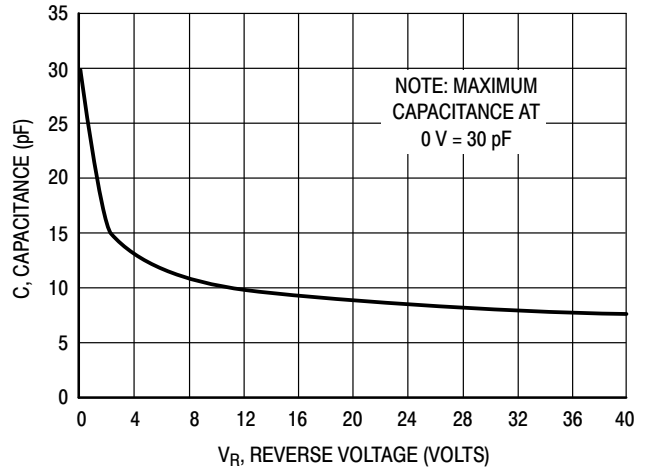


Figure 7. Maximum Capacitance

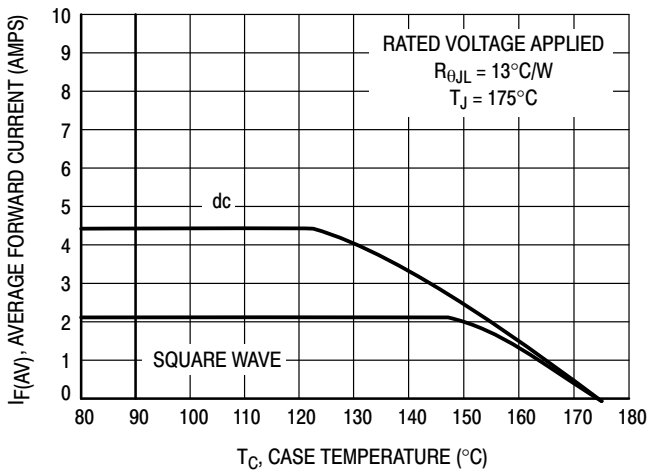


Figure 8. Current Derating, Case

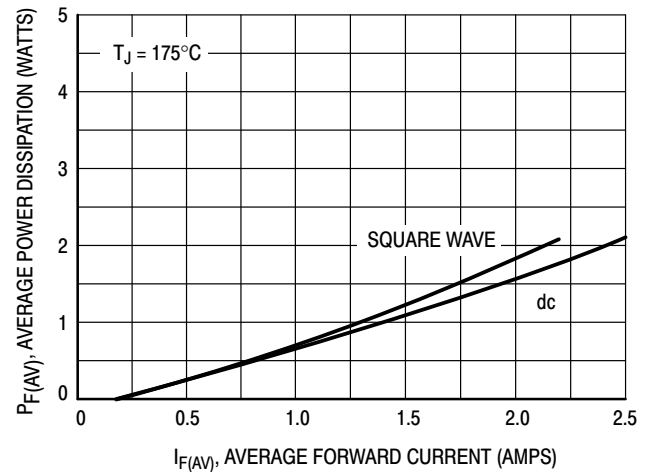


Figure 9. Power Dissipation

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

ON Semiconductor®



SCALE 1:1

Polarity Band



SCALE 1:1

Non-Polarity Band

SMB
CASE 403A-03
ISSUE J

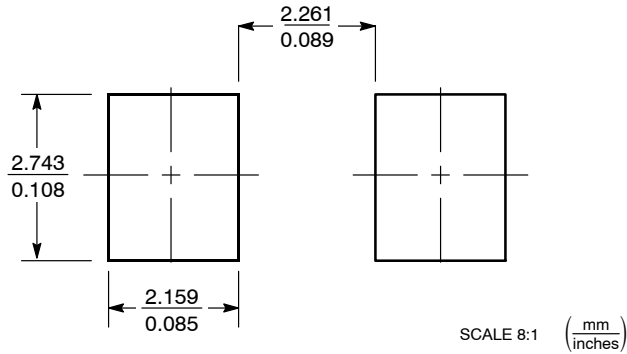
DATE 19 JUL 2012



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION b SHALL BE MEASURED WITHIN DIMENSION L1.

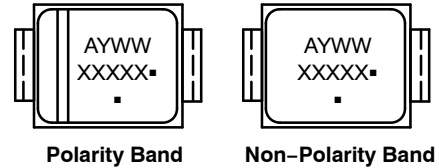
| DIM | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|-----------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 1.95 | 2.30 | 2.47 | 0.077 | 0.091 | 0.097 |
| A1 | 0.05 | 0.10 | 0.20 | 0.002 | 0.004 | 0.008 |
| b | 1.96 | 2.03 | 2.20 | 0.077 | 0.080 | 0.087 |
| c | 0.15 | 0.23 | 0.31 | 0.006 | 0.009 | 0.012 |
| D | 3.30 | 3.56 | 3.95 | 0.130 | 0.140 | 0.156 |
| E | 4.06 | 4.32 | 4.60 | 0.160 | 0.170 | 0.181 |
| HE | 5.21 | 5.44 | 5.60 | 0.205 | 0.214 | 0.220 |
| L | 0.76 | 1.02 | 1.60 | 0.030 | 0.040 | 0.063 |
| L1 | 0.51 REF | | | 0.020 REF | | |

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



- XXXXX = Specific Device Code
 - A = Assembly Location
 - Y = Year
 - WW = Work Week
 - = Pb-Free Package
- (Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

| | | |
|-------------------------|--------------------|--|
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| DESCRIPTION: | SMB | PAGE 1 OF 1 |

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